



Near-Infrared (0.9 - 1.7 μm) 640x512 InGaAs Focal Plane Array

FPA0640P15F-17-T1 : with 1-Stage Thermoelectric Cooler

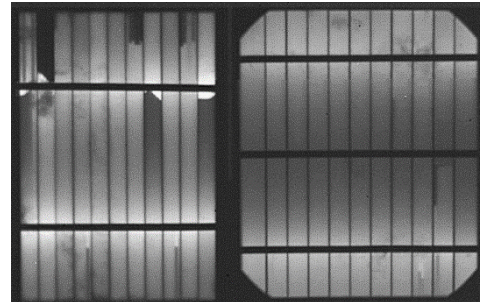
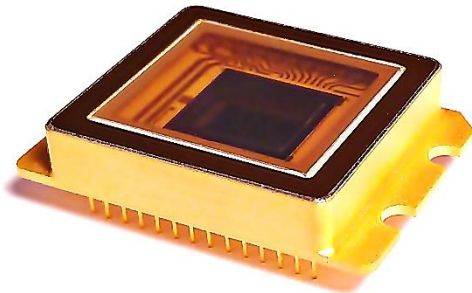
FPA0640P15F-17-T2 : with 2-Stage Thermoelectric Cooler

FEATURES

- 640x512 Array Format
- 0.9 μm -1.7 μm Spectral Range
- 28-pin Metal SDIP Package
- Embedded Thermoelectric Cooler
- Typical Pixel Operability >99.5%
- Quantum Efficiency >65%
- Built-in Temperature Sensor
- Snapshot ITR/IWR and IMRO Readout Modes
- 2, 4 or 8 Outputs with up to 18MHz Pixel Rate
- Windowing Capability

APPLICATIONS

- Near-Infrared Imaging
- Covert Surveillance
- Semiconductor/Solar Panel Inspection
- Medical Science and Biology
- Fiberoptic Telecommunication
- See through Fog/Smoke
- Ice/Slush/Moisture Mapping
- Industrial Thermal Imaging
- Astronomy and Scientific



GENERAL DESCRIPTIONS

PARAMETER	UNIT	VALUE
Sensor Technology	---	Planar InGaAs PIN
Spectral Range	μm	0.9 -1.7
Actual Pixel Array	---	640 x 512
Effective Pixel Array	---	636 x 508
Pixel Pitch	μm	15
Image Size	mm	9.6 x 7.68
Package Type	---	28-pin Metal SDIP Package
Package Size L x W x T	mm	36.1 x 25.4 x 7.3 (without pins)
Weight	g	19.5 (± 0.5) (for both package)



SPECIFICATIONS (¹ITS = 20°C)

Parameter	Unit	Typical Value	Conditions
^{2,3} Dark Current	fA	≤ 20	Photopixel Biased @ -0.5 V
^{2,3} Quantum Efficiency * Fill Factor (QE _{EFF})	%	≥ 70	λ = 1.0 μm - 1.6 μm
^{2,3} Response Nonuniformity	%	≤ 5	At 50% Well Occupation
^{2,3} Response Nonlinearity (Max. Peak-to-Peak Deviation)	%	≤ 2	15% - 85% Well Occupation Range
Charge Capacity	@ High Gain	0.043	ROIC Specifications
	@ Mid Gain	0.12	
	@ Low Gain	1.44	
Readout Noise	@ High Gain	< 35	ROIC Specifications
	@ Mid Gain	< 60	
	@ Low Gain	< 500	
Noise-Equivalent Irradiance (NEI)	ph# / cm ² -s	≤ 1.4 x 10 ⁹	Mid Gain, Integration Time = 16.7 ms, λ = 1.55 μm
Mean Detectivity	cm-√Hz/W	≥ 2 x 10 ¹³	
Output Swing	V	2.25	
³ Minimum Integration Period	μs	<1	
^{2,3} Pixel Operability	%	≥ 99.5	Percentage of Pixels with QE _{EFF} Deviation within ±20%*(QE _{EFF} Mean).
⁴ Maximum Cooling Capability (ΔT _{MAX})	FPA0640P15F-17-T1	≥ 35	T _{Heatsink} = 20°C
	FPA0640P15F-17-T2	≥ 55	

1. Readings from integrated temperature sensor (ITS).

2. These items are defined for central effective pixel array (636x508). Their values correspond to default operation conditions.

3. Contact us for further information.

4. Adequate heatsink and thermal interface material are the prerequisites for stable operation.

ABSOLUTE MAXIMUM RATINGS

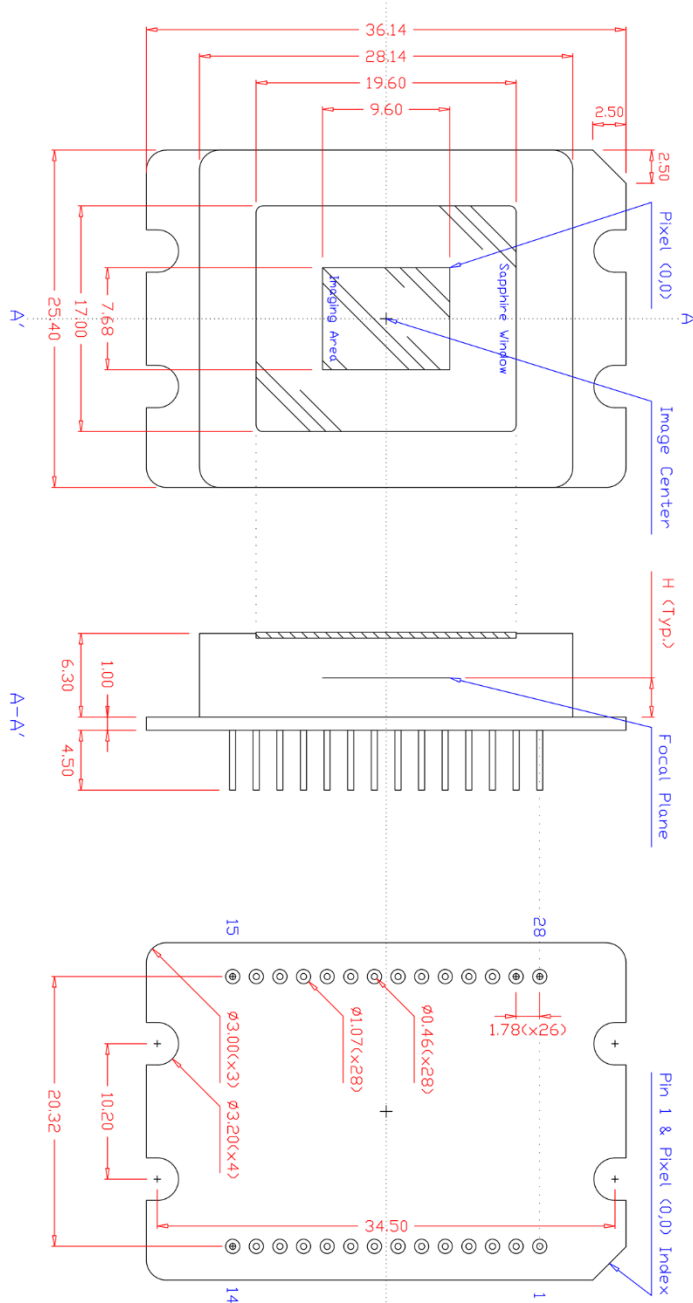
Parameter	Unit	Min.	Max.
⁵ Operation Temperature	°C	-40	+70
⁵ Storage Temperature	°C	-40	+70
⁶ Power Consumption	mW	---	200

5. Non-condensing environment.

6. Without powering on the thermoelectric cooler.



PACKAGE OUTLINE (Unit: mm)



BOTTOM VIEW

SIDE VIEW

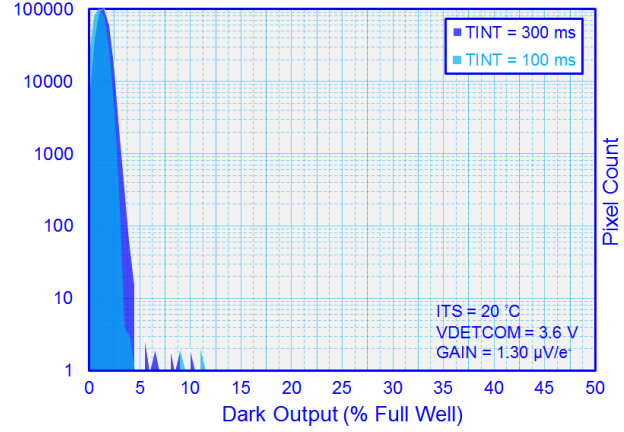
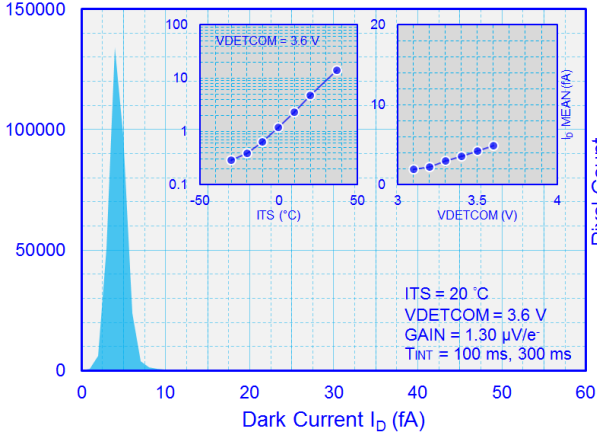
Model	H
FPA0640P15F-17-T1	2.95
FPA0640P15F-17-T2	4.55

TOP VIEW

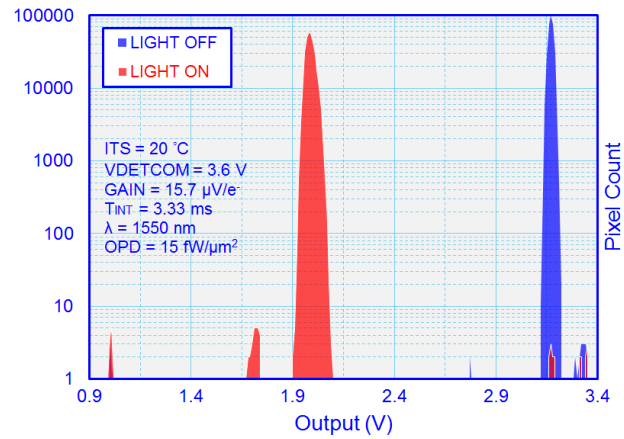
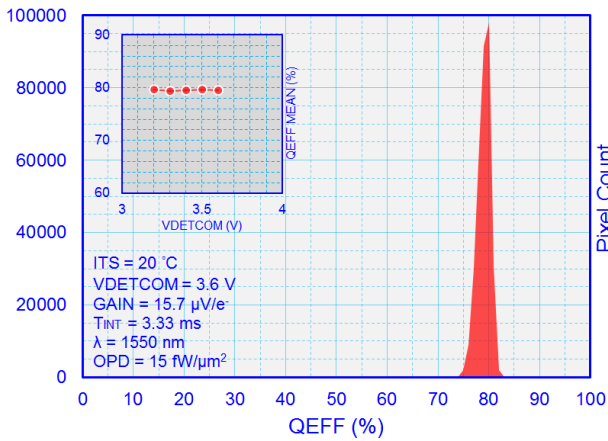


EXAMPLE CURVES

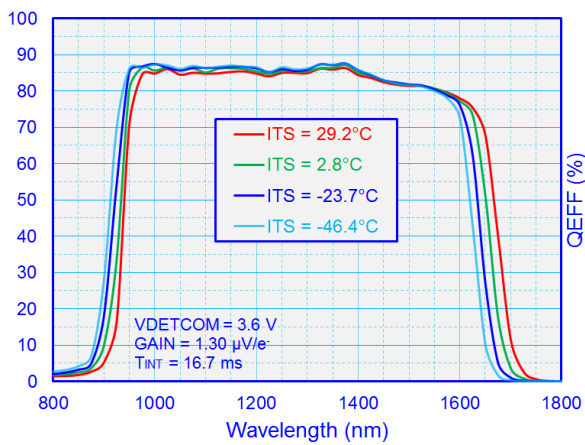
Histograms of Dark Condition



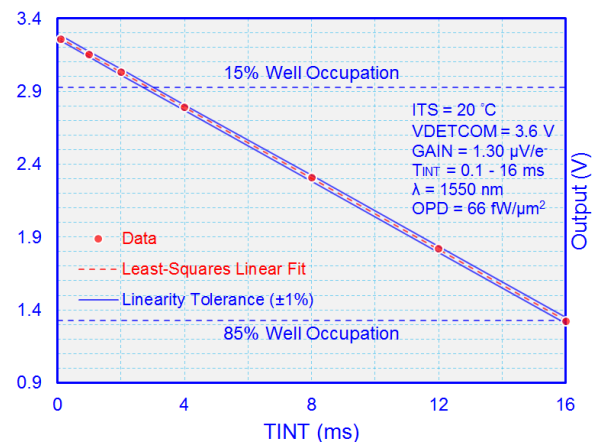
Histograms of Illumination Condition



QEFF Spectrum



Output Linearity



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